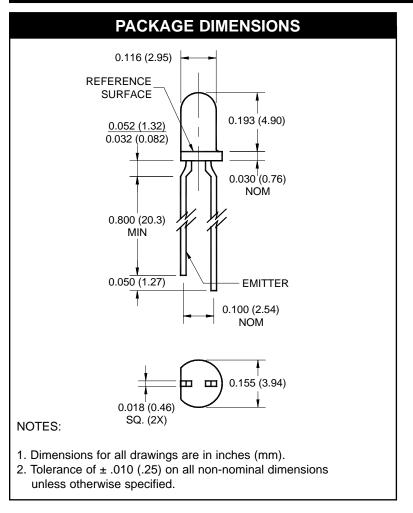
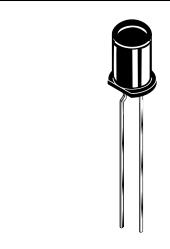
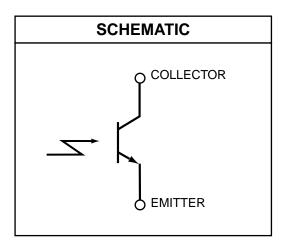


QSC112 QSC113 QSC114







DESCRIPTION

The QSC112/113/114 is a silicon phototransistor encapsulated in an infrared transparent, black T-1 package.

FEATURES

- Tight production distribution.
- Steel lead frames for improved reliability in solder mounting.
- Good optical-to-mechanical alignment.
- Plastic package is infrared transparent black to attenuate visible light.
- Mechanically and spectrally matched to the QECXXX LED.
- Black plastic body allows easy recognition from LED.



QSC112 QSC113 QSC114

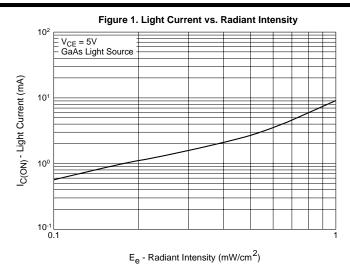
ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise specified)							
Parameter	Symbol	Rating	Unit				
Operating Temperature	T _{OPR}	-40 to +100	°C				
Storage Temperature	T _{STG}	-40 to +100	°C				
Soldering Temperature (Iron)(2,3,4)	T _{SOL-I}	240 for 5 sec	°C				
Soldering Temperature (Flow)(2,3)	T _{SOL-F}	260 for 10 sec	°C				
Collector-Emitter Voltage	V _{CE}	30	V				
Emitter-Collector Voltage	V _{EC}	5	V				
Power Dissipation ⁽¹⁾	P _D	100	mW				

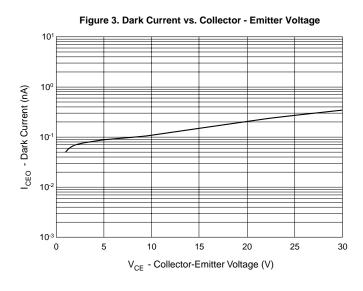
- 1. Derate power dissipation linearly 1.33 mW/°C above 25°C.
- 2. RMA flux is recommended.
- 3. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 4. Soldering iron 1/16" (1.6mm) minimum from housing.
- 5. λ = 880 nm, AlGaAs.

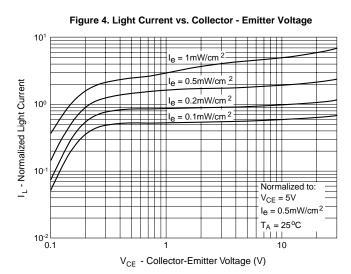
ELECTRICAL / OPTICAL CHARACTERISTICS (T _A = 25°C)								
PARAMETER	TEST CONDITIONS	SYMBOL	MIN	TYP	MAX	UNITS		
Peak Sensitivity Wavelength		λ _{PS}	_	880	_	nm		
Reception Angle		θ	_	±8	_	Deg.		
Collector-Emitter Dark Current	$V_{CE} = 10 \text{ V, Ee} = 0$	I _{CEO}	_	_	100	nA		
Collector-Emitter Breakdown	$I_C = 1 \text{ mA}$	BV _{CEO}	30	_	_	V		
Emitter-Collector Breakdown	I _E = 100 μA	BV _{ECO}	5	_	_	V		
On-State On-State Collector QSC112	F- 0.5 \\\/2		1	_	4	mA		
On-State On-State Collector QSC113	Ee = 0.5 mW/cm ² , $V_{CE} = 5 V^{(5)}$	Ic(on)	2.40	_	9.60			
On-State On-State Collector QSC114		•	4.00	_	_			
Saturation Voltage	Ee = 0.5 mW/cm ² , $I_C = 0.5 \text{ mA}^{(5)}$	VCE(sat)	_	_	0.4	V		
Rise Time	$V_{CC} = 5 \text{ V}, R_L = 100 \Omega$ $I_C = 2 \text{ mA}$	t _r	_	5.0	_			
Fall Time		t _f	_	5.0	_	μs		

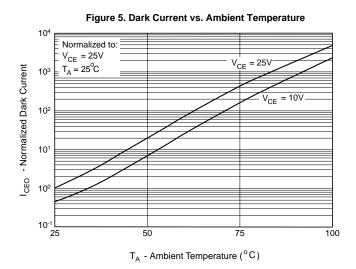


QSC112 QSC113 QSC114











QSC112 QSC113 QSC114

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